

HCG600FF120A2H1

1200V/600A Half Bridge IGBT Module

Description

The HCG600FF120A2H1 is a Half Bridge IGBT Power Module. It integrates high performance IGBT chips and offers lower losses and higher energy for the applications such as motor drive, inverter and welding machines.

Features

- 1200V600A
- $V_{CE(sat)}(typ) = 1.60V$
- Lower losses and higher energy
- High speed switching

Applications

- Motor drive
- Inverter
- Welding machines
- Power supply
- UPS



Circuit diagram

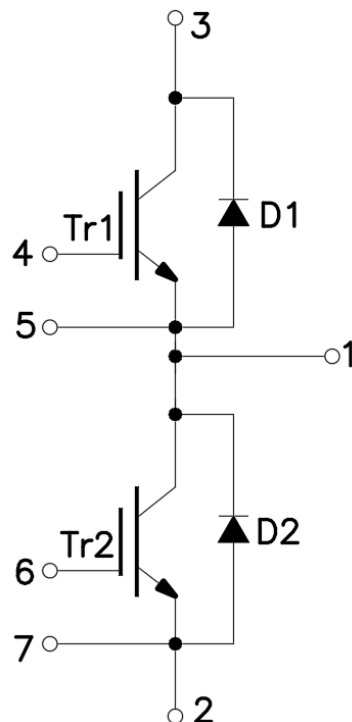


Figure 1. Out drawing & circuit diagram for HCG600FF120A2H1

HCG600FF120A2H1

1200V/600A Half Bridge IGBT Module

Pin Configuration and Marking Information

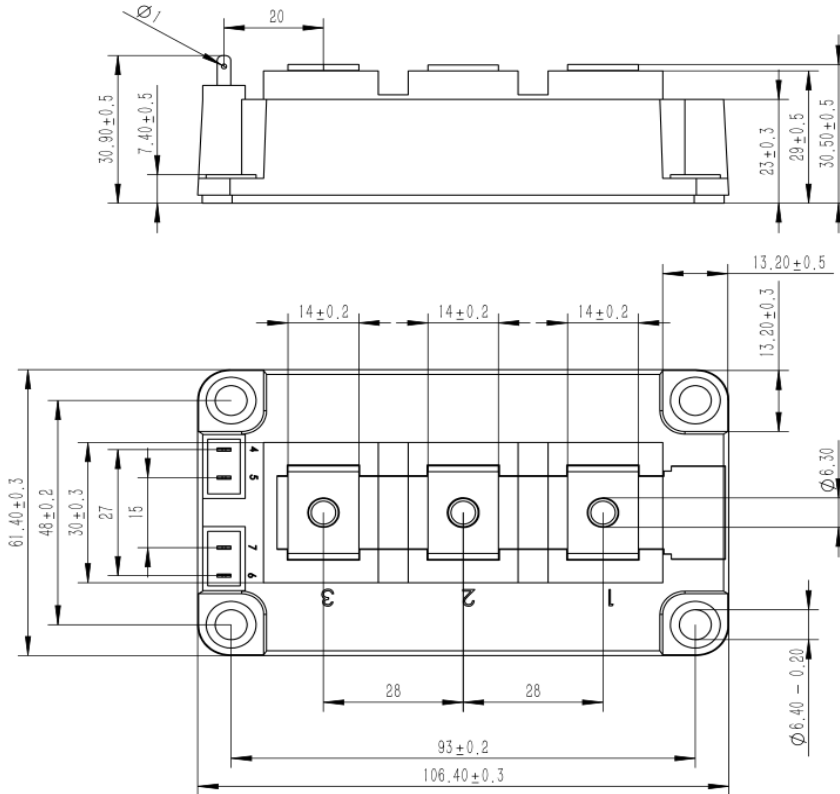


Figure 2. Pin configuration

HCG600FF120A2H1

1200V/600A Half Bridge IGBT Module

Module

Parameter	Condition	Value	Unit
Isolation Voltage	RMS, f = 50Hz, t = 1min	3.4	kV
Material of module baseplate	-	Cu	-
Creepage distance	terminal to heatsink	47	mm
	terminal to terminal	26	
Clearance	terminal to heatsink	29	mm
	terminal to terminal	14	
CTI	-	>200	-
Module lead resistance, terminals – chip	T _c = 25°C	0.8	mΩ
Mounting torque for module mounting	M6	3 to 6	Nm
Weight	-	315	g

Maximum Ratings (T_j = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V _{CES}	Collector-Emitter Voltage	G-E Short	1200	V
V _{GES}	Gate-Emitter Voltage	C-E Short	±20	V
I _C	DC Continuous Collector Current	T _c = 100°C	600	A
I _{CM}	Pulse Collector Current	t _p = 1ms, Note1	1200	A
P _C	Maximum Power Dissipation	T _c = 25°C, IGBT	3333	W
I _F	Diode Forward Current	-	600	A
I _{FRM}	Repetitive peak forward Current	t _p = 1ms, Note1	1200	A
T _{jmax}	junction temperature	-	-40 to 175	°C
T _{vjop}	Operating junction temperature	-	-40 to 150	°C
T _{stg}	Storage temperature	-	-40 to 125	°C

Note1: Pulse width limited by maximum junction temperature

NTC characteristics

Symbol	Parameter	Condition	Value			Unit
			Min.	Typ.	Max.	
R ₂₅	Resistance	T _c = 25°C	-	5	-	kΩ
$\Delta R/R$	Deviation of R ₁₀₀	T _c = 100°C, R ₁₀₀ = 493 Ω	-5	-	5	%
P ₂₅	Power dissipation	T _c = 25°C	-	-	20	mW
B _{25/50}	B-value	R ₂ = R ₂₅ exp [B _{25/50} (1/T ₂ - 1/(298,15 K))]	-	3375	-	K
B _{25/80}	B-value	R ₂ = R ₂₅ exp [B _{25/80} (1/T ₂ - 1/(298,15 K))]	-	3411	-	K
B _{25/100}	B-value	R ₂ = R ₂₅ exp [B _{25/100} (1/T ₂ - 1/(298,15 K))]	-	3433	-	K

HCG600FF120A2H1

1200V/600A Half Bridge IGBT Module

IGBT Electrical characteristics (T_j=25°C unless otherwise specified, chip)

Symbol	Item	Condition	Value			Unit	
			Min.	Typ.	Max.		
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C =600A V _{GE} =15V	T _j =25°C	-	1.60	1.92	V
			T _j =125°C	-	1.73	-	V
			T _j =150°C	-	1.80	-	V
			T _j =175°C	-	1.85	-	V
V _{GE(th)}	Gate-Emitter threshold Voltage	I _C =23mA, V _{CE} =V _{GE}	5.0	5.8	6.5	V	
Q _G	Gate charge	V _{GE} = -15V to +15V	-	6.9	-	uC	
R _{Gint}	Internal gate resistor	-	T _j =25°C	-	0.53	-	Ω
C _{ies}	Input Capacitance	V _{CE} =25V,	T _j =25°C	-	86.4	-	nF
C _{oes}	Output Capacitance	V _{GE} =0V		-	2.35	-	nF
C _{res}	Reverse transfer Capacitance	f=1MHz		-	0.66	-	nF
I _{CES}	Collector- Emitter Cut off Current	V _{CE} =1200V, V _{GE} =0V	T _j =25°C	-	-	1	mA
I _{GES}	Gate-Emitter Leakage Current	V _{GE} =20V, V _{CE} =0V	T _j =25°C	-	-	1	uA
t _{d(on)}	Turn-on delay time	V _{CC} =600V I _C =600A V _{GE} =+15V/-8V R _{Gon} = R _{Goff} =2.2 Ω Inductive load	T _j =25°C	-	400	-	ns
			T _j =150°C	-	394	-	ns
t _r	Rise time		T _j =25°C	-	68	-	ns
			T _j =150°C	-	84	-	ns
t _{d(off)}	Turn-off delay time		T _j =25°C	-	797	-	ns
			T _j =150°C	-	858	-	ns
t _f	Fall time		T _j =25°C	-	107	-	ns
			T _j =150°C	-	258	-	ns
E _{on}	Turn-on power dissipation		T _j =25°C	-	22.6	-	mJ
			T _j =150°C	-	52.4	-	mJ
E _{off}	Turn-off power dissipation	T _j =25°C	-	77.1	-	mJ	
		T _j =150°C	-	80.0	-	mJ	
R _{th(j-c)}	Thermal Resistance, Junction to Case (IGBT)		-	0.045	-	°C/W	
R _{th(c-s)}	Thermal Resistance, Case to sink (Conductive Grease applied) , Note1		-	0.015	-	°C/W	

Note1: Assumes Thermal Conductivity of grease is 2.8 W/m · K and thickness is 50um.

HCG600FF120A2H1

1200V/600A Half Bridge IGBT Module

Freewheeling Diode Electrical characteristics ($T_j=25^\circ\text{C}$ unless otherwise specified, chip)

Symbol	Item	Condition	Value			Unit	
			Min.	Typ.	Max.		
V_F	Diode Forward Voltage	$I_F=600\text{A}, V_{GE}=0\text{V}$	$T_j=25^\circ\text{C}$	-	1.64	1.97	V
			$T_j=125^\circ\text{C}$	-	1.48	-	V
			$T_j=150^\circ\text{C}$	-	1.49	-	V
			$T_j=175^\circ\text{C}$	-	1.44	-	V
t_{rr}	Reverse recovery time	(Switch side) $V_{CC}=600\text{V}, I_C=600\text{A}$	$T_j=25^\circ\text{C}$	-	316	-	ns
			$T_j=150^\circ\text{C}$	-	514	-	ns
I_{RM}	Peak reverse recovery Current	$V_{GE}=+15\text{V}/-8\text{V}, R_G=2.2\Omega$ (FRD side)	$T_j=25^\circ\text{C}$	-	387	-	A
			$T_j=150^\circ\text{C}$	-	555	-	A
Q_{rr}	Recovered charge	$V_{rr}=600\text{V}, I_F=600\text{A}$ $V_{GE}=-8\text{V}$	$T_j=25^\circ\text{C}$	-	46.7	-	μC
			$T_j=150^\circ\text{C}$	-	107.7	-	μC
E_{rr}	Reverse recovered energy	Inductive load switching operation	$T_j=25^\circ\text{C}$	-	23.9	-	mJ
			$T_j=150^\circ\text{C}$	-	47.2	-	mJ
$R_{th(j-c)}$	Thermal Resistance, Junction to Case (Diode)		-	0.063	-	$^\circ\text{C}/\text{W}$	
$R_{th(c-s)}$	Thermal Resistance, Case to sink (Conductive Grease applied), Note1		-	0.020	-	$^\circ\text{C}/\text{W}$	

Note1: Assumes Thermal Conductivity of grease is $2.8 \text{ W/m} \cdot \text{K}$ and thickness is $50\mu\text{m}$.

Test Conditions

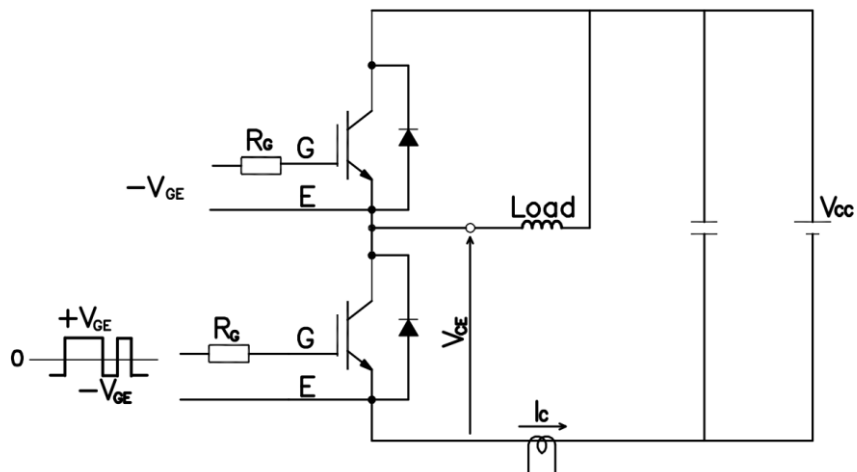


Figure 3. Switching time measure circuit

HCG600FF120A2H1

1200V/600A Half Bridge IGBT Module

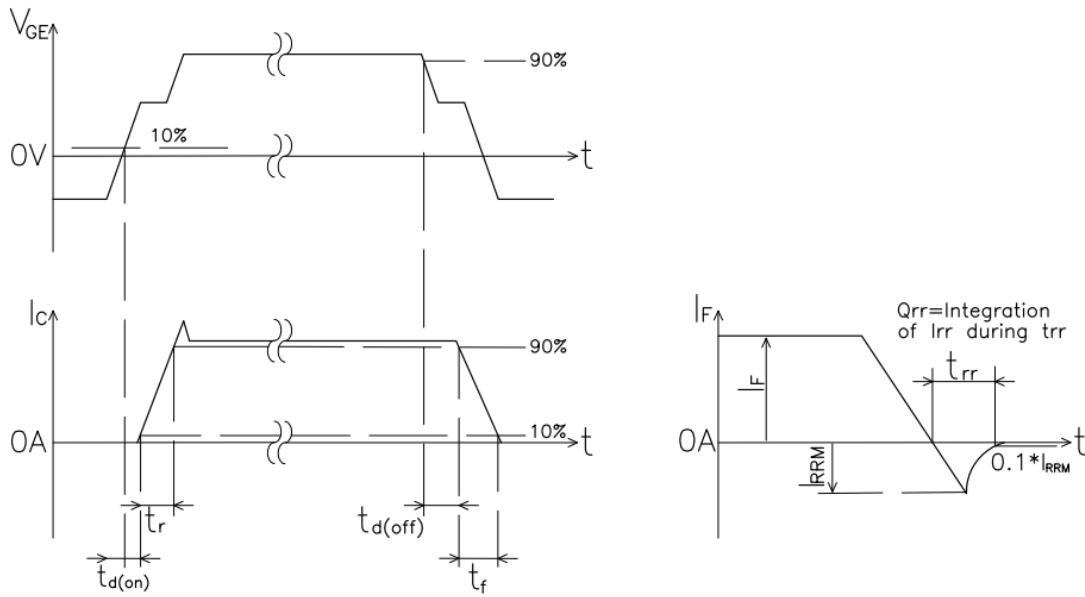


Figure 4. Switching time definition

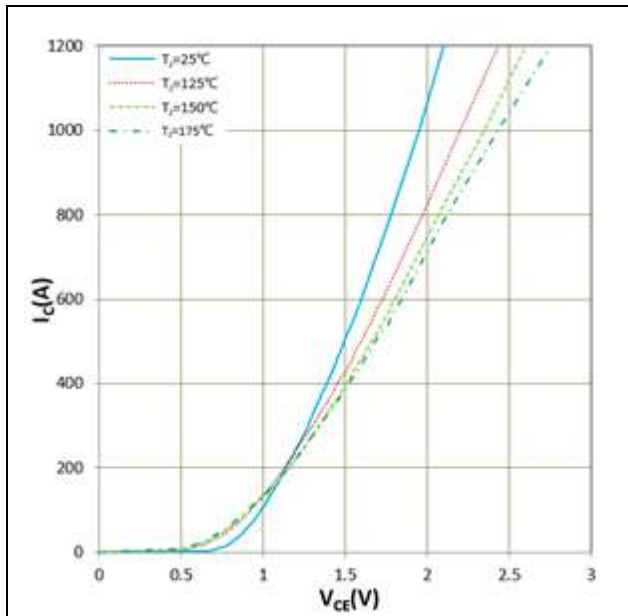


Figure 5. I_c vs V_{CE}
 $V_{GE} = 15V$

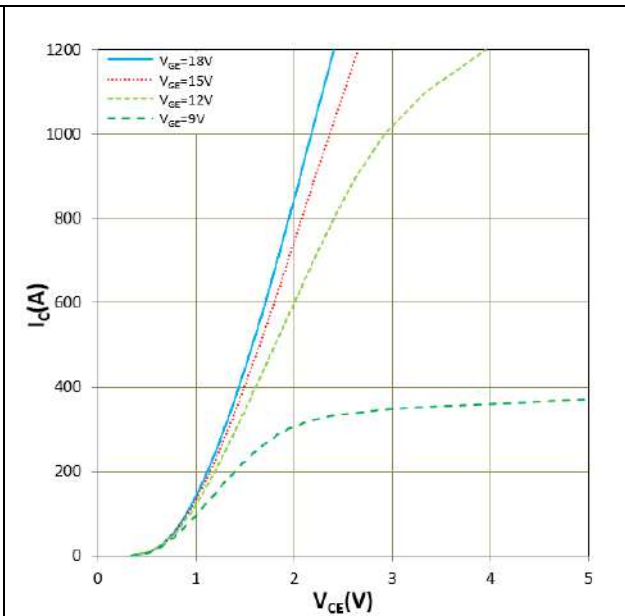


Figure 6. I_c vs V_{CE}
 $T_j = 175^\circ C$

HCG600FF120A2H1

1200V/600A Half Bridge IGBT Module

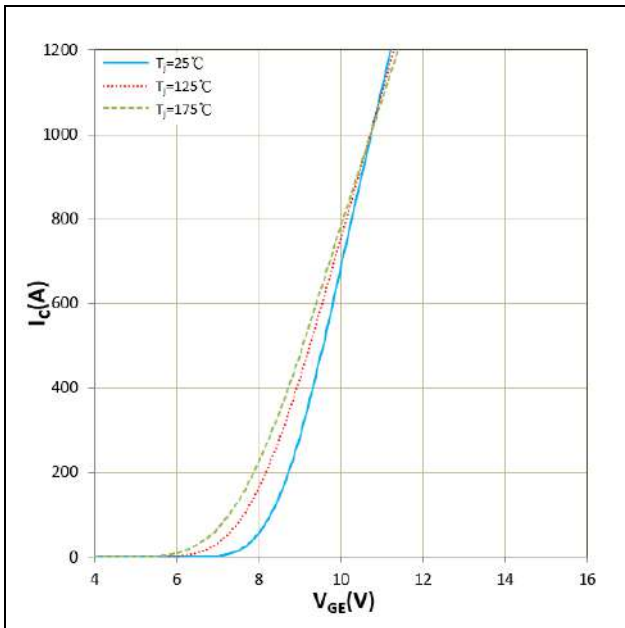


Figure 7. I_c vs V_{GE}
 $V_{CE}=20V$

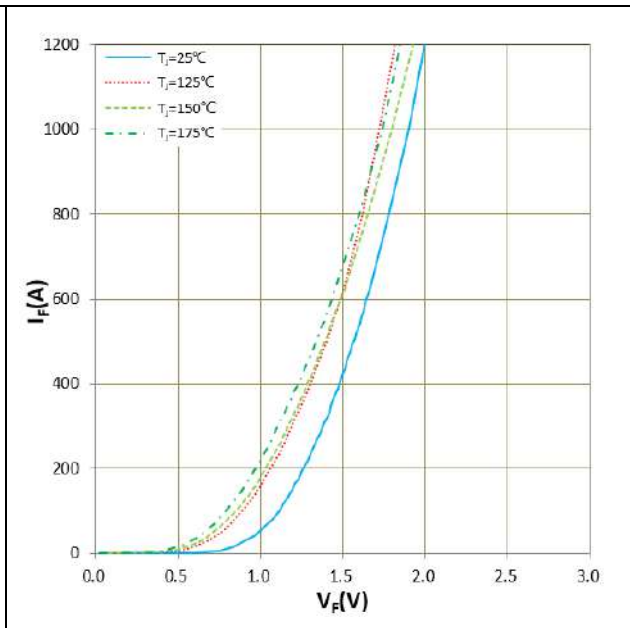


Figure 8. I_F vs V_F

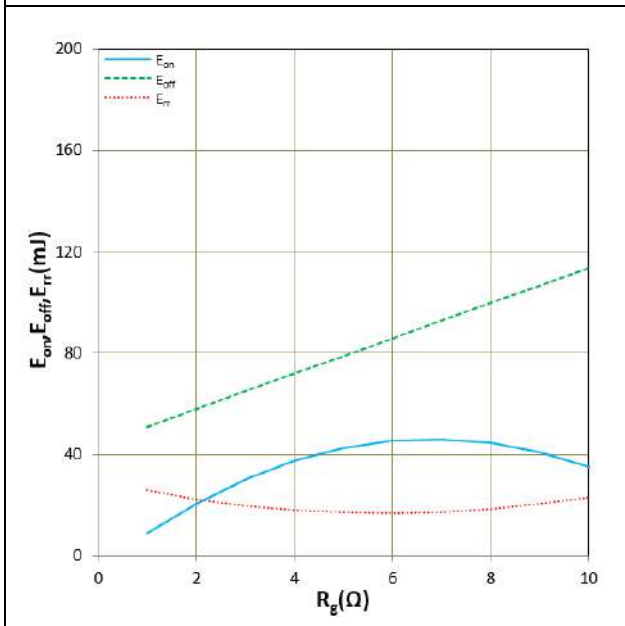


Figure 9. E_{on} , E_{off} , E_{tr} vs R_g (Typ)
 $V_{CC}=600V$, $V_{GE}=+15V/-8V$, $I_c=600A$, $T_j=25^\circ C$
Inductive Load

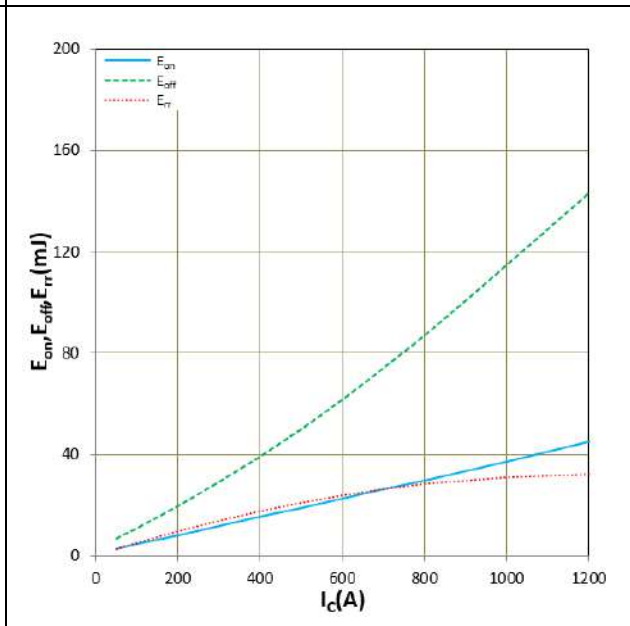


Figure 10. E_{on} , E_{off} , E_{tr} vs I_c (Typ)
 $V_{CC}=600V$, $V_{GE}=+15V/-8V$, $R_g=2.2\Omega$, $T_j=25^\circ C$
Inductive Load

HCG600FF120A2H1

1200V/600A Half Bridge IGBT Module

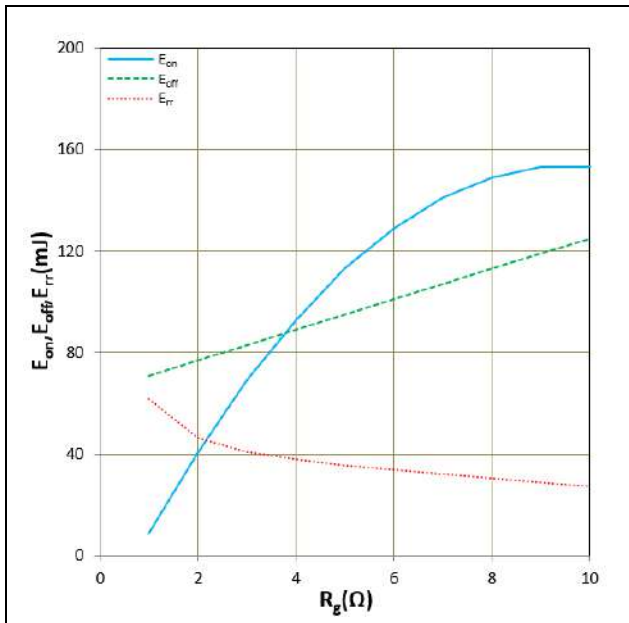


Figure 11. E_{on} , E_{off} , E_{rr} vs R_g (Typ)
 $V_{CC}=600V$, $V_{GE}=+15V/-8V$, $I_C=600A$, $T_j=150^\circ C$
 Inductive Load

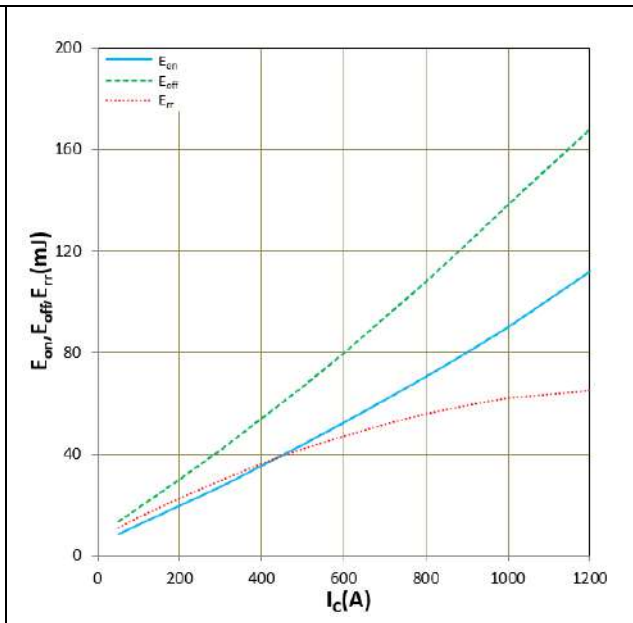


Figure 12. E_{on} , E_{off} , E_{rr} vs I_c (Typ)
 $V_{CC}=600V$, $V_{GE}=+15V/-8V$, $R_g=2.2\Omega$, $T_j=150^\circ C$
 Inductive Load

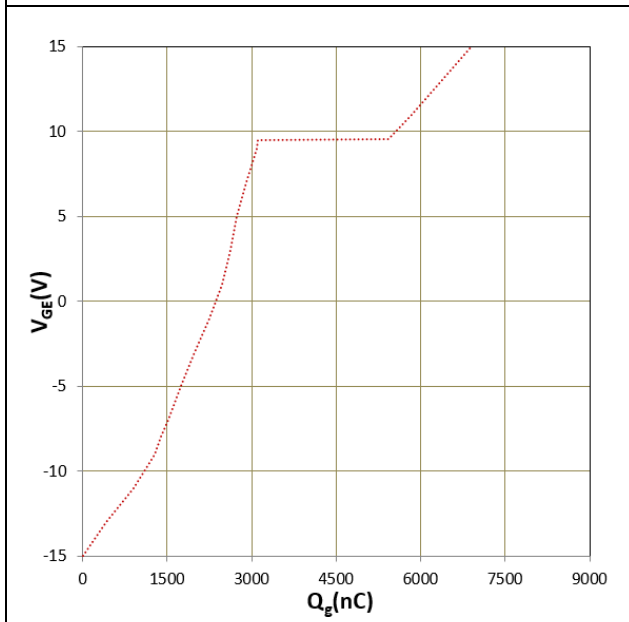


Figure 13. Gate charge

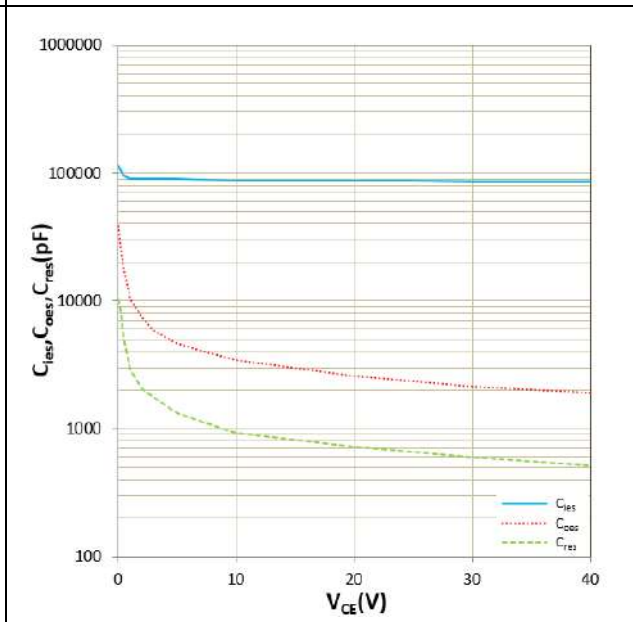


Figure 14. C_{ies} , C_{oes} , C_{res} vs V_{CE}
 $T_j=25^\circ C$, $f=1MHz$

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1200V/600A Half Bridge IGBT Module

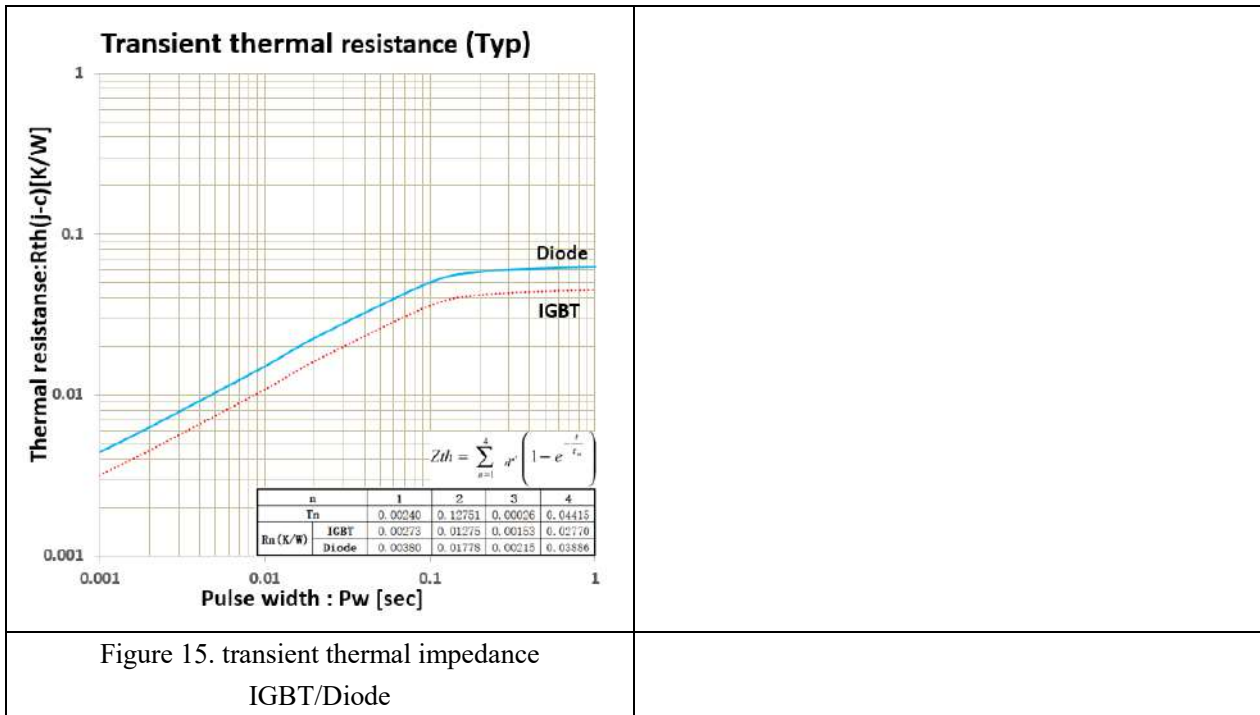


Figure 15. transient thermal impedance
IGBT/Diode

IMPORTANT NOTICE:

This product data sheet describes the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively under the terms and conditions of the supply agreement. There will be no guarantee or of any kind for the product and its characteristics.

The data contained in this document is exclusively intended for technically trained staff. You and your technical departments will have to evaluate the product's suitability for the intended application and the completeness of the product data concerning such application.

Due to technical requirements, our product may contain dangerous substances. For information on the types in question, please contact the sales staff responsible for you.

Changes to this product data sheet are reserved.

Please contact the sales staff (sales@hiitio.com) for further information on the product, technology, delivery terms, conditions and prices. □

Instruction note

Naming rules for power module product models (Industrial module)

Product Model			
HC	G	100	FF 120 E3 A
Hecheng Code			
Module type G : IGBT module D : FRD module S : SiC module H : Si/SiC hybrid			
Current level (A) 50~900			
Topology structure FZ : A switch unit FF : Half bridge FS : Three phase F4 : H Bridge F3L : Three level DF : Boost Circuit FD : Braking Circuit FP : Rectification+Inverter+Control move AL : ANPC CL : Chopper			
Voltage level (x10) (V) 650~2200			
Packaging form+features (A...Z)	A1: 34 mm B1: Easy 1B B2: Easy 2B... D1: Flow0 E0: E0 E3: ED3 E6: EPM2 E9: ED3H	A2: 62 mm B1A B3: Easy 3B... D2: Flow1 E1: Econo 2... E4: E4 E7: EPM3 F0: F0	B1B... D3: Flow2 E2: E2 E5: ED3S E8: EconoPIM3 P2: EPM2
Feature :A: Special Code Nil: Standard			

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